HD74HC221

Dual Monostable Multivibrators (with Schmitt Trigger Input)

HITACHI

Description

Each multivibrator features both a negative, A, and a positive, B, transition triggered input, either of which can be used as an inhibit. Also included is a clear inpt that when taken low resets the one shot. The HD74HC221 can be triggered on the positive transition of teh clear while A is held low and B is held high.

This device is a non-retriggerable, and therefore cannot be retriggered until the output pulse times out.

The output pulse equation is simply:

 $t_{\rm W} = 0.7 \cdot ({\rm Rext}) \cdot ({\rm Cext})$

Features

• High Speed Operation

• High Output Current: Fanout of 10 LSTTL Loads

Wide Operating Voltage: V_{CC} = 2 to 6 V

Low Input Current: 1 μA max
 Low Quiescent Supply Current

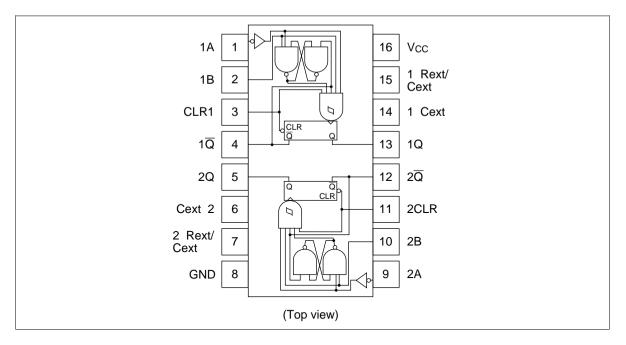
Function Table

Inputs			Outputs		
Clear	Α	В	Q	Q	
L	X	Х	L	Н	
X	Н	Х	L	Н	
X	Х	L	L	Н	
Н	L	\int		T	
Н	_	Н		T	
$\overline{\int}$	L	Н	Л	T	

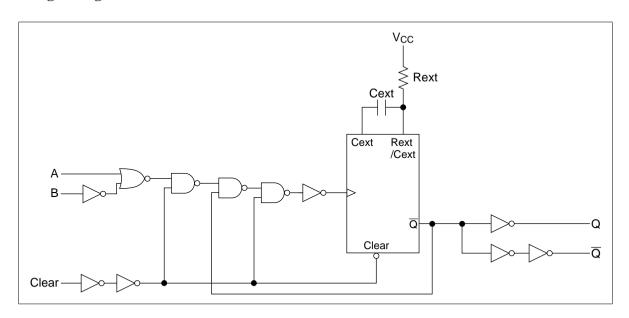


HD74HC221

Pin Arrangement



Logic Diagram



DC Characteristics

	Sym-	\mathbf{V}_{cc}	Ta =	25°C		Ta = +85°	–40 to C			
Item	bol	(V)	Min	Тур	Max	Min	Max	Unit	Test Conditions	
Input voltage	V_{IH}	2.0	1.5	_	_	1.5	_	V		
		4.5	3.15	_	_	3.15	_			
		6.0	4.2	_	_	4.2	_			
	V_{IL}	2.0	_	_	0.5	_	0.5	V		
		4.5	_	_	1.35	_	1.35			
		6.0	_	_	1.8	_	1.8			
Output voltage	V_{OH}	2.0	1.9	2.0	_	1.9	_	V	$Vin = V_{IH} \text{ or } V_{IL}$	$I_{OH} = -20 \mu A$
		4.5	4.4	4.5	_	4.4	_			
		6.0	5.9	6.0	_	5.9	_			
		4.5	4.18	_	_	4.13	_			$I_{OH} = -4 \text{ mA}$
		6.0	5.68	_	_	5.63	_			$I_{OH} = -5.2 \text{ mA}$
	V_{OL}	2.0	_	0.0	0.1	_	0.1	V	$Vin = V_{IH} \text{ or } V_{IL}$	$I_{OL} = 20 \mu A$
		4.5	—	0.0	0.1	—	0.1			
		6.0	_	0.0	0.1	_	0.1			
		4.5	_	_	0.26	_	0.33			I _{OL} = 4 mA
		6.0	_	_	0.26	_	0.33			$I_{OL} = 5.2 \text{ mA}$
Input current	lin	6.0		_	±0.1	_	±1.0	μΑ	$Vin = V_{CC} \text{ or GND}$	
Quiescent supply	I _{cc}	6.0	_	_	130	_	220	μΑ	$Vin = V_{CC} \text{ or GND}$	lout = 0 μA
current		6.0	_	_	130	_	220			Rext/Cent = 0.5 V _{CC}

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AC Characteristics ($C_L = 50 \text{ pF}$, Input $t_r = t_f = 6 \text{ ns}$)

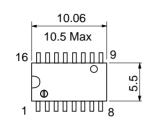
Ta = -40 to Ta = 25° C +85°C

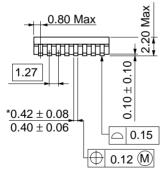
Item	Symbol	V _{cc} (V)	Min	Тур	Max	Min	Max	Unit	Test Condition	าร
Trigger	t _{PLH}	2.0	_	_	210	_	265	ns	A, B or Clear to	Q
propagation delay		4.5	_	_	42	_	53	=		
time		6.0	_	_	36	_	45	_		
	t _{PHL}	2.0	_	_	240	_	300	ns	A, B or Clear to	o Q
		4.5	_	_	48	_	60	_		
		6.0	_	_	41	_	51	=		
Propagation delay	t _{PHL}	2.0	_	_	170	_	215	ns	Clear to Q	
time		4.5	_	_	34	_	43	=		
		6.0	_	_	29	_	37	_		
	t _{PLH}	2.0	_	_	180	_	225	ns	Clear to Q	
		4.5	_	_	36	_	45	=		
		6.0	_	_	31	_	38	_		
Pulse width	t _w	2.0	80	_	_	100	_	ns	A, B, Clear	
		4.5	16	_	_	20	_	_		
		6.0	14	_	_	17	_	=		
Minimum output	t _{wq (min)}	2.0	_	1.5	_	_	_	μs	Cext = 28 pF	Rext = $6 \text{ k}\Omega$
pulse width		4.5	_	450	_	_	_	ns	=	Rext = $2 k\Omega$
		6.0	_	380	_	_	_	=		
Output pulse width	t _{wQ}	4.5	0.63	0.7	0.77	_	_	ms	Cext = 0.1 μ F Rext = 10 kΩ	
Output rise/fall	t _{TLH}	2.0	_	_	75	_	95	ns		
time	t _{THL}	4.5	_	_	15	_	19	_		
		6.0	_	_	13	_	16	_		
Input capacitance	Cin	_	_	5	10	_	10	pF		

Caution in use: In order to prevent any malfunctions due to noise, connect a high-frequency performance capacitor between $V_{\rm cc}$ and GND, and keep the wiring between the external components and Cext, Rext/Cext pins as short as possible.

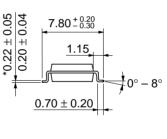
Unit: mm 19.20 20.00 Max 16 7.40 Max 6.30 1.3 1.11 Max 7.62 5.06 Max 2.54 Min 0.51 Min $0.25^{+0.13}_{-0.05}$ 0.48 ± 0.10 2.54 ± 0.25 $0^{\circ} - 15^{\circ}$ Hitachi Code DP-16 **JEDEC** Conforms EIAJ Conforms Weight (reference value) 1.07 g

Unit: mm





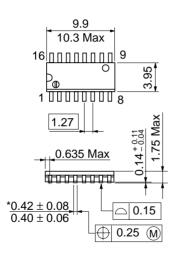


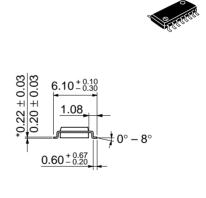


Hitachi Code	FP-16DA
JEDEC	_
EIAJ	Conforms
Weight (reference value)	0.24 g

*Dimension including the plating thickness
Base material dimension

Unit: mm





*Dimension including the plating thickness
Base material dimension

Hitachi Code	FP-16DN
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	0.15 g

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